



US00D897996S

(12) **United States Design Patent**  
**Mei**

(10) **Patent No.:** **US D897,996 S**

(45) **Date of Patent:** **\*\* Oct. 6, 2020**

(54) **EARPHONE**

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(\*\*) Term: **15 Years**

(21) Appl. No.: **29/685,023**

(22) Filed: **Mar. 26, 2019**

(51) **LOC (12) Cl.** ..... **14-01**

(52) **U.S. Cl.**

USPC ..... **D14/223**

(58) **Field of Classification Search**

USPC ..... D14/223, 205; D24/174; 128/864, 865,  
128/866; 455/90.3, 575.1, 569.1

CPC ..... H04R 1/10; H04R 25/00; H04R 1/1016;  
H04R 1/1066; H04R 5/033; H04R  
5/0335; H04R 1/1091; H04R 1/1058;  
H04R 1/1041; H04R 1/1083

See application file for complete search history.

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*Primary Examiner* — Paula Allen Greene

(57) **CLAIM**

The ornamental design for an earphone, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of an earphone showing my new design;

FIG. 2 is a front elevation view thereof;

FIG. 3 is a rear elevation view thereof;

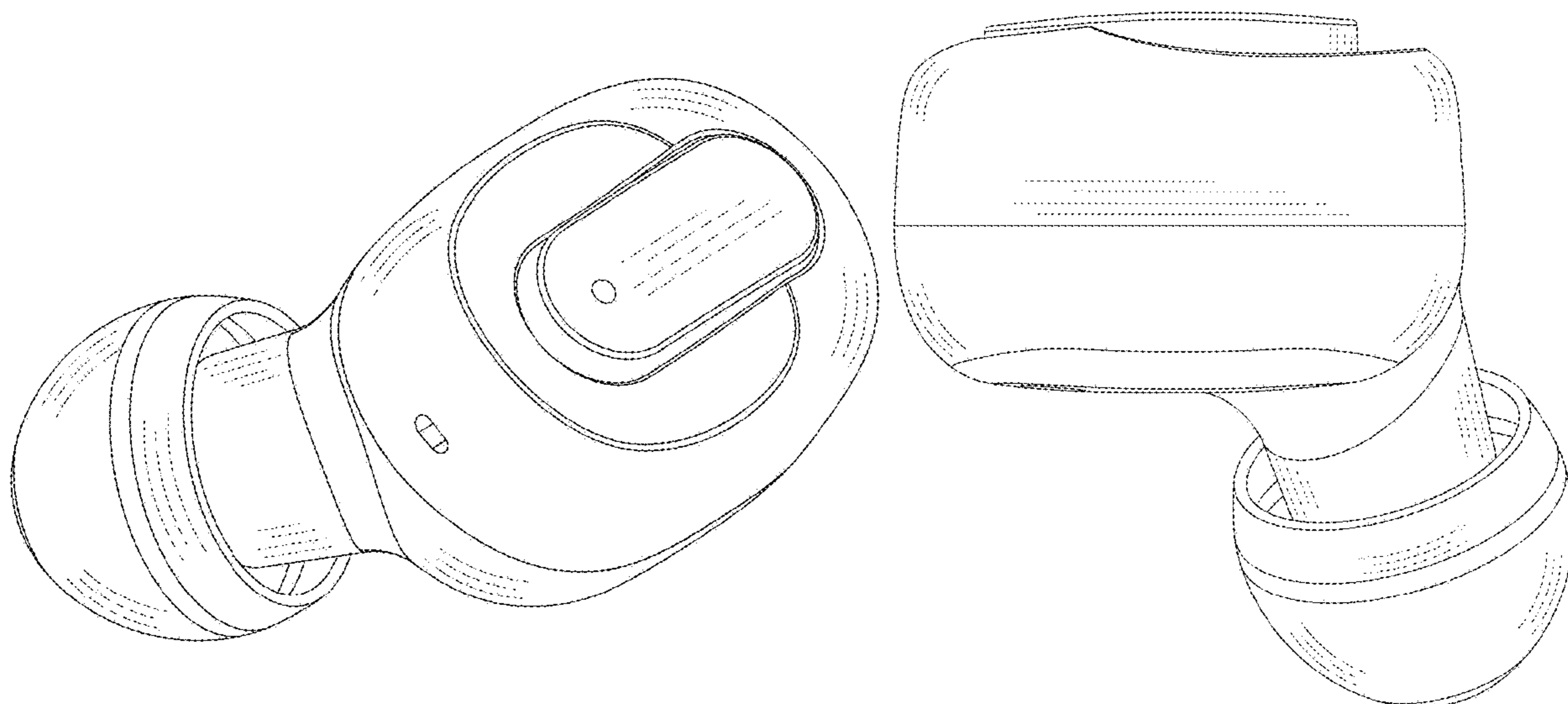
FIG. 4 is a left side elevation view thereof;

FIG. 5 is a right side elevation view thereof;

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom plan view thereof.

**1 Claim, 7 Drawing Sheets**



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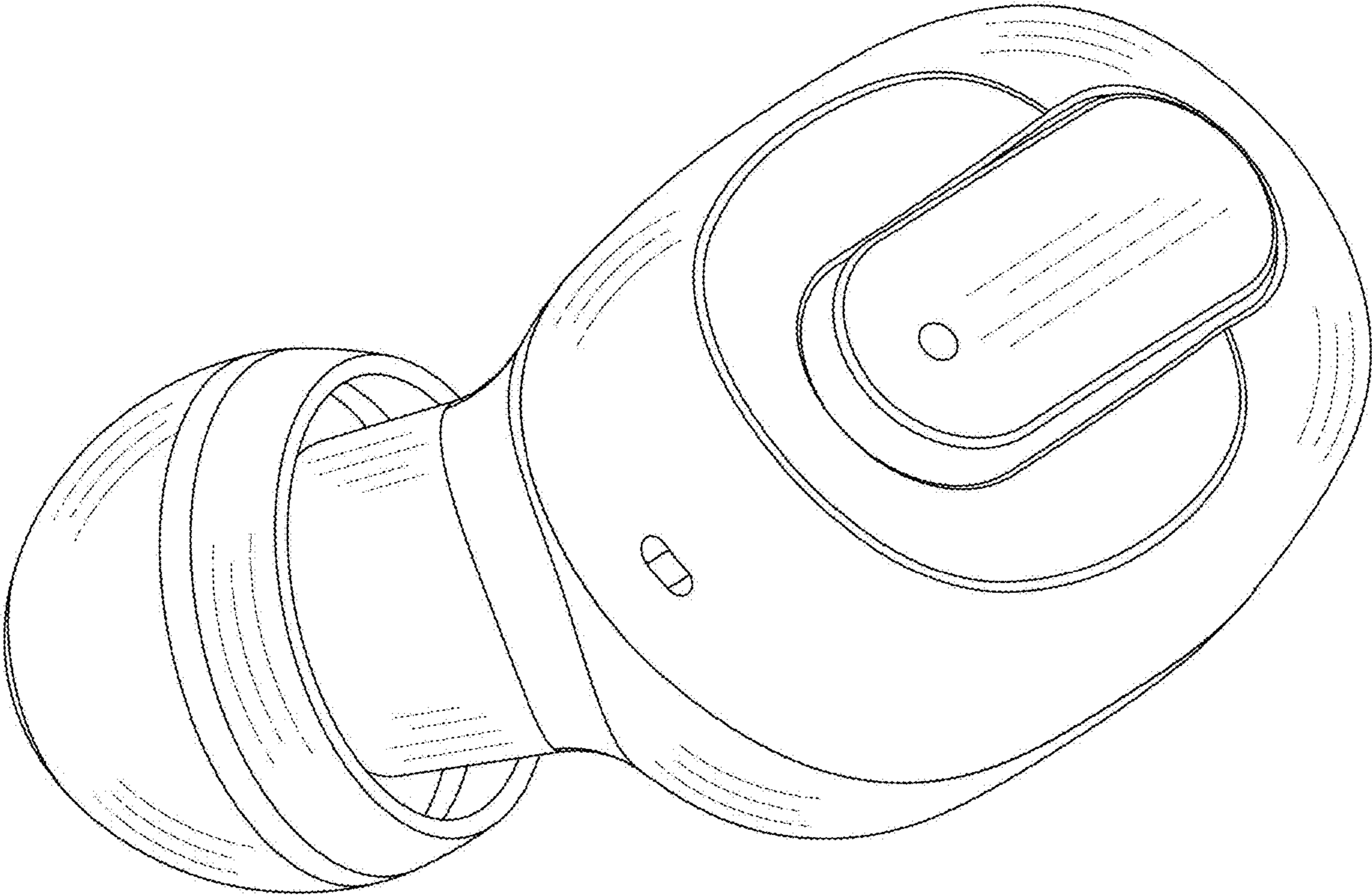


FIG.1

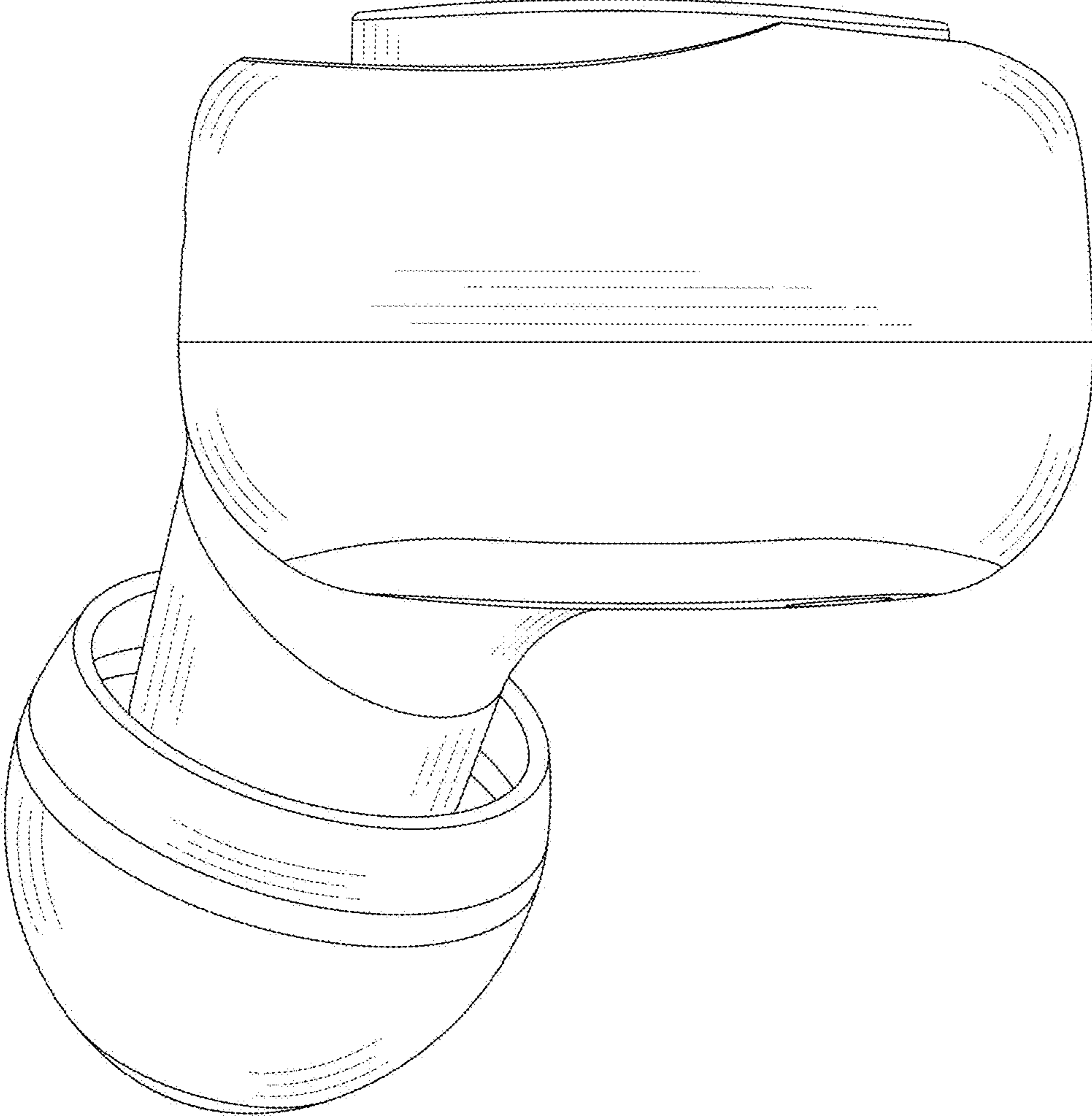


FIG.2

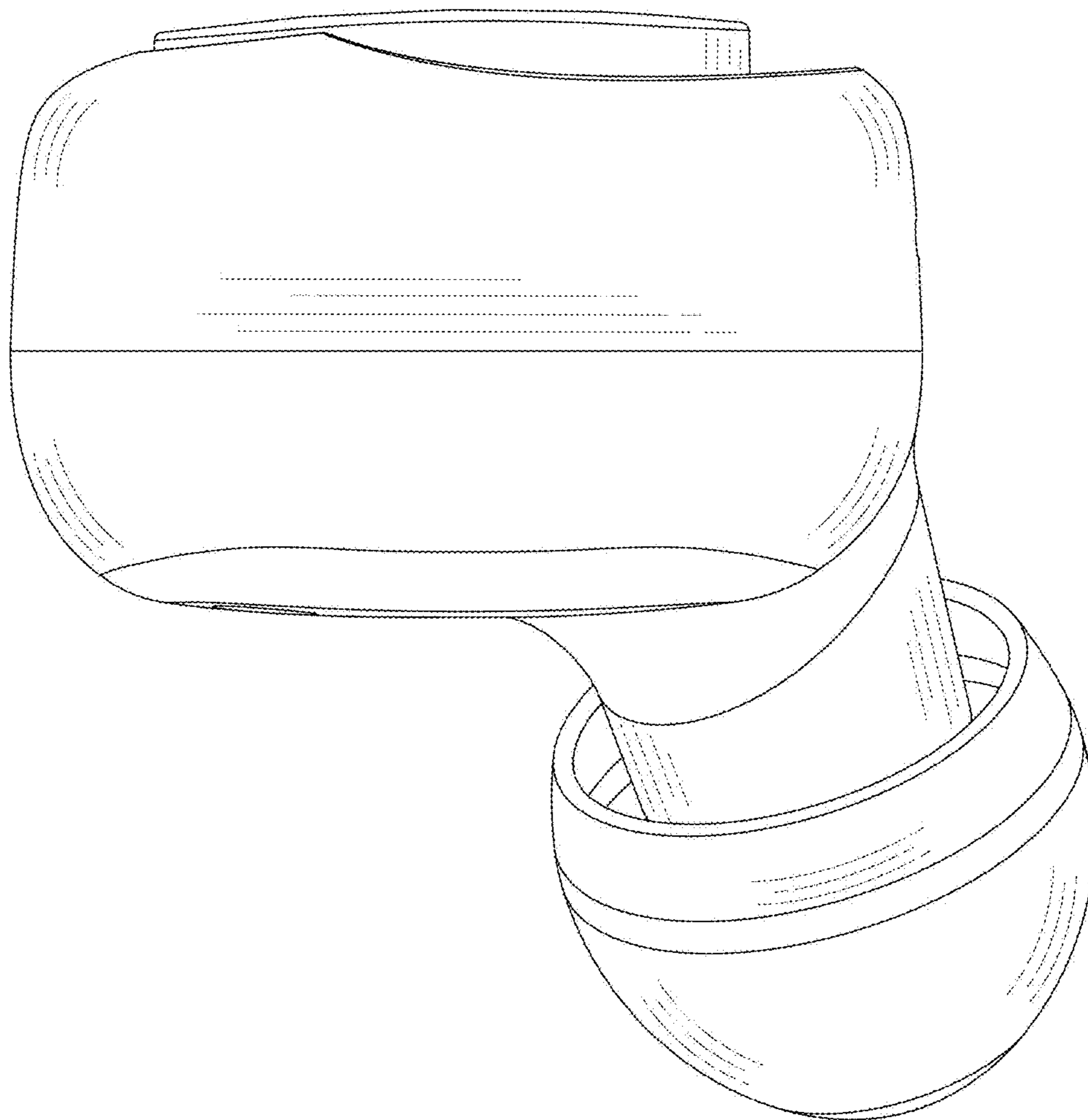


FIG.3

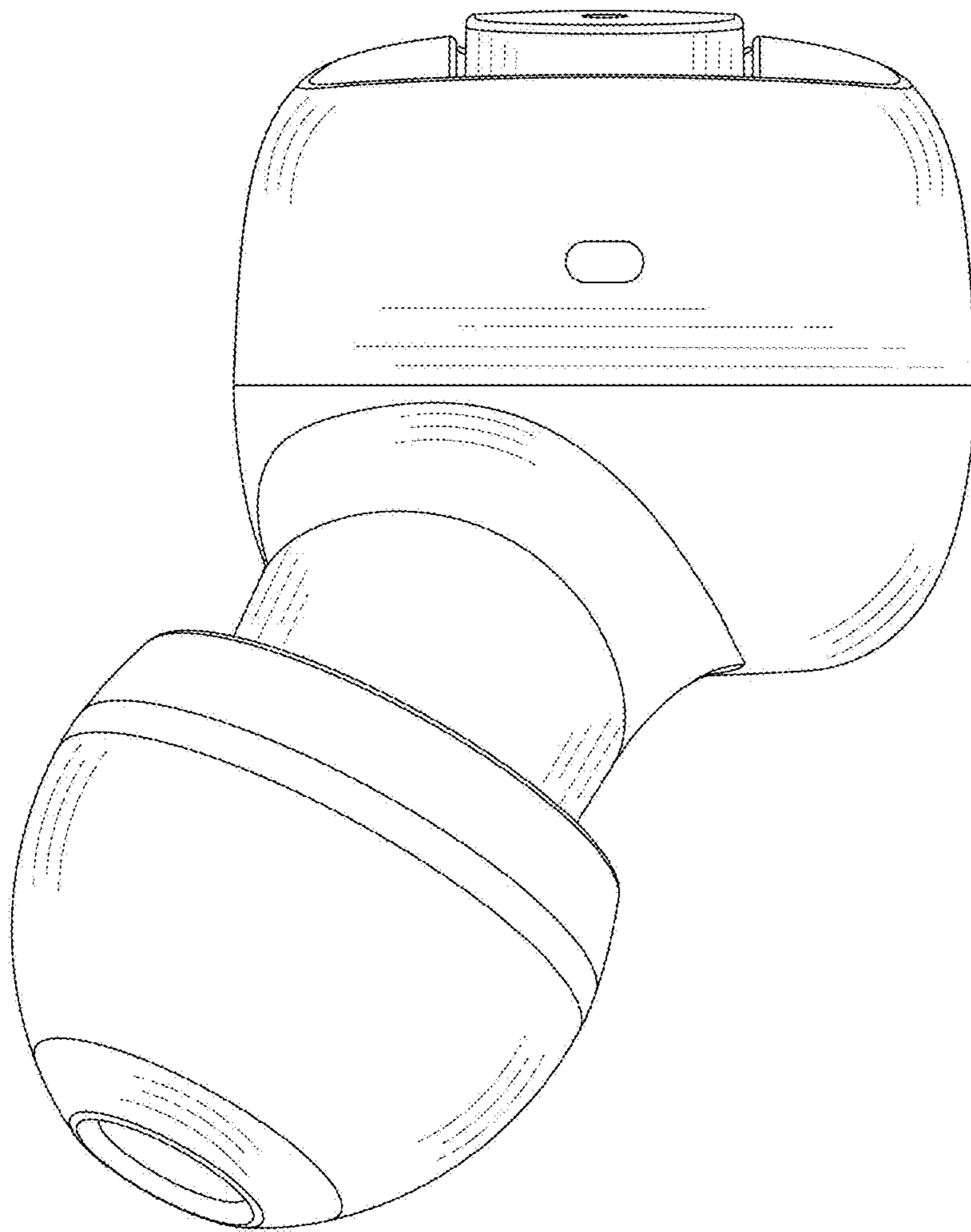


FIG.4

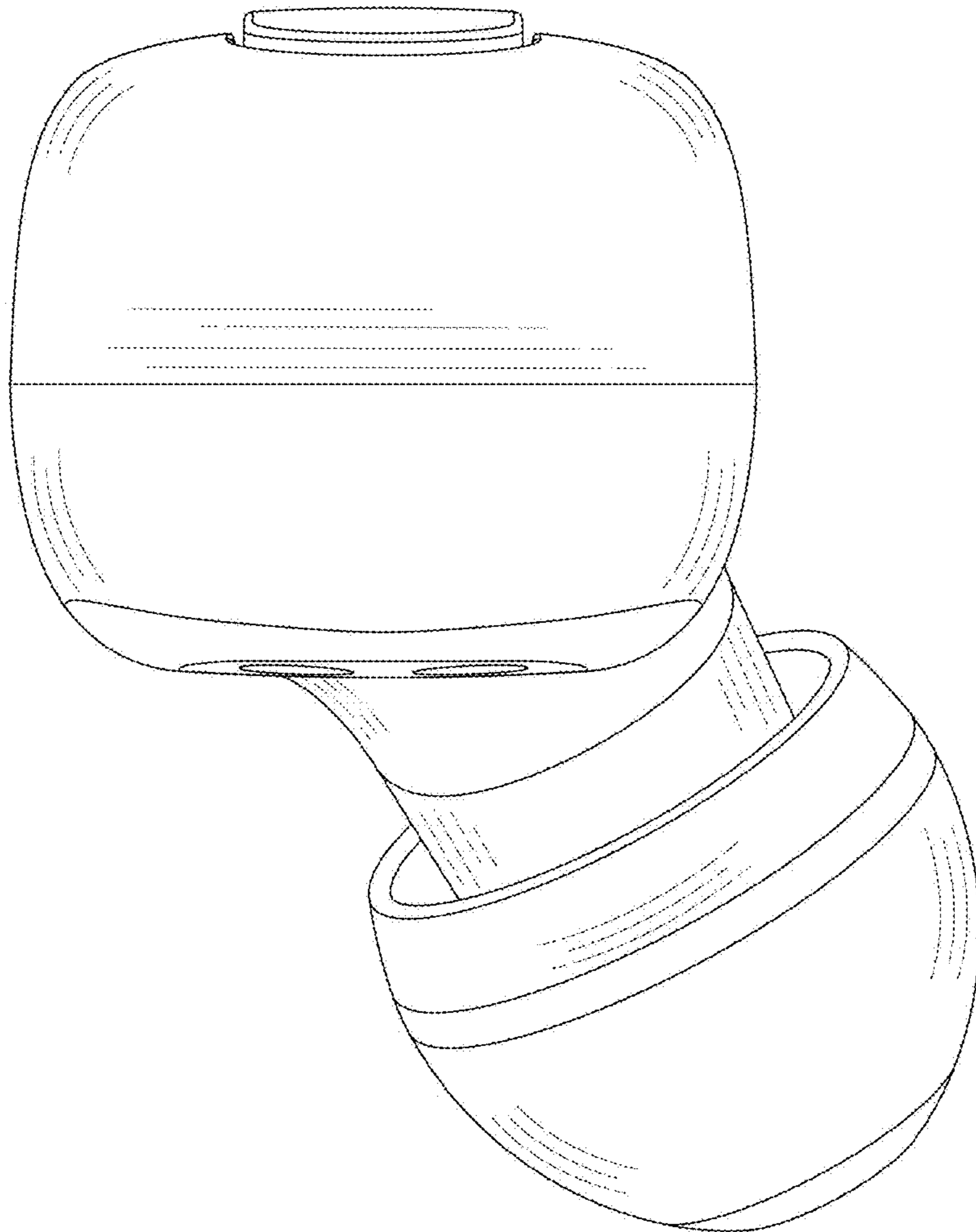


FIG. 5

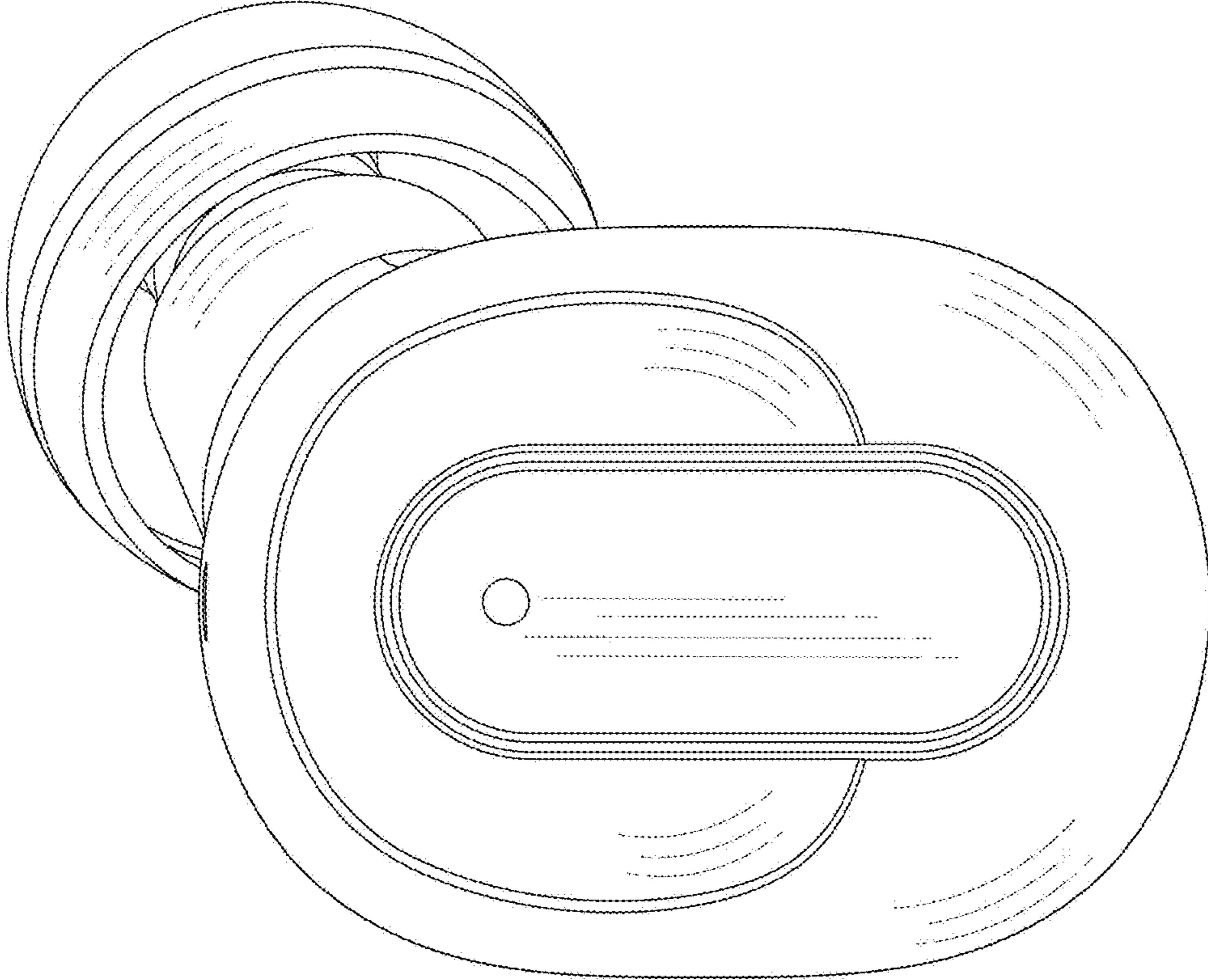


FIG.6



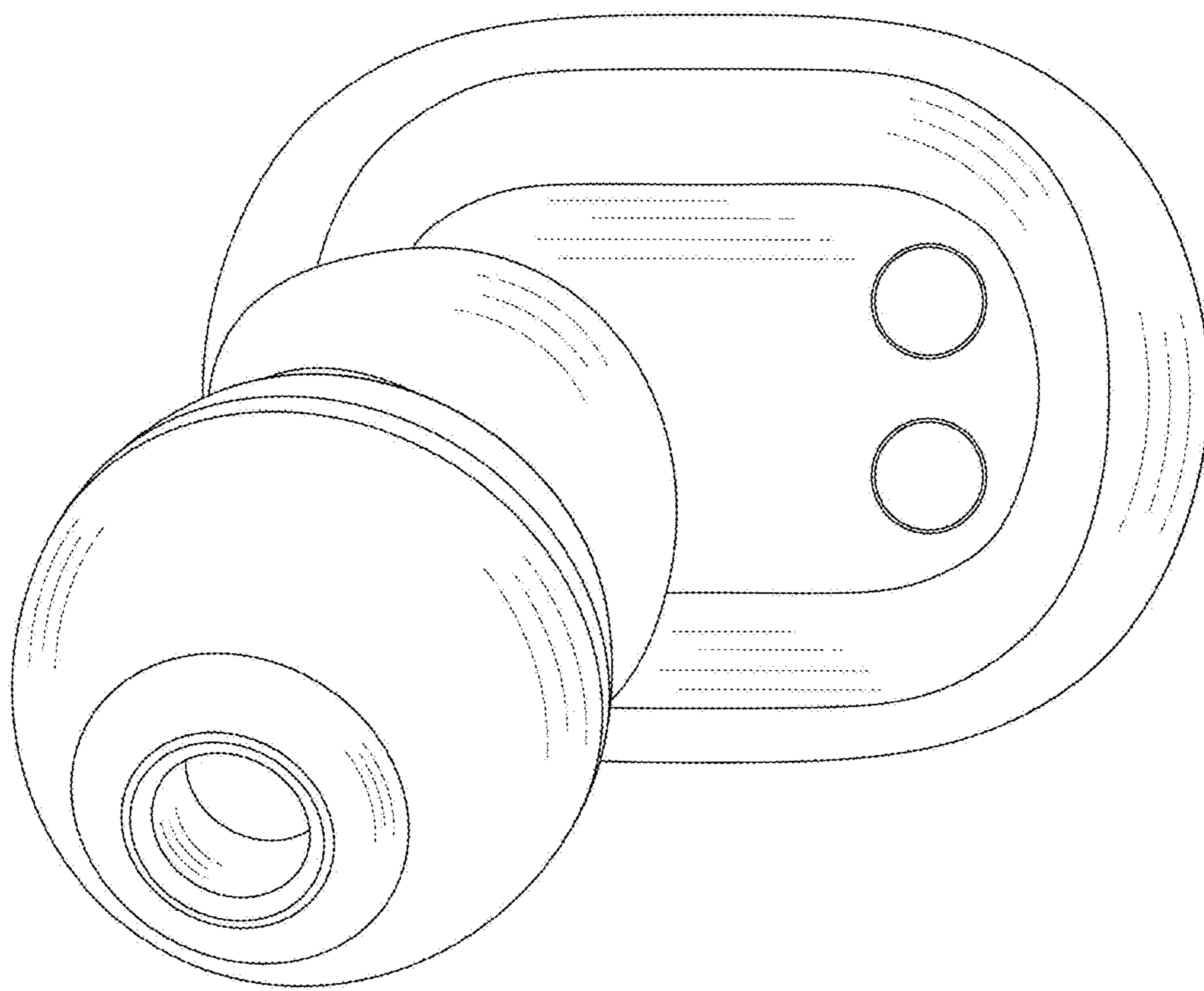


FIG.7